

/ Descriptions

TO-263

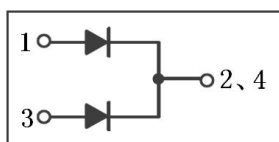
/ Features

/ Applications

OR-ing

DC-DC

/ Equivalent Circuit

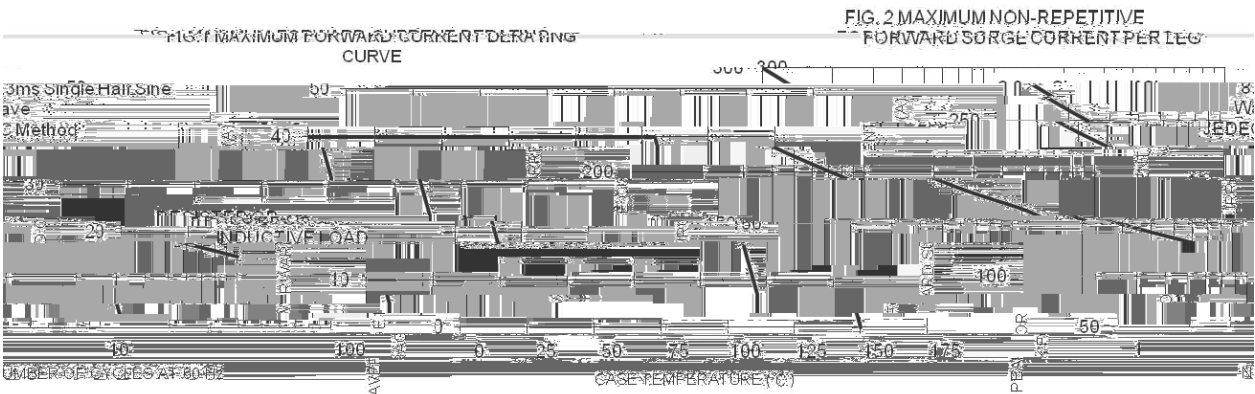
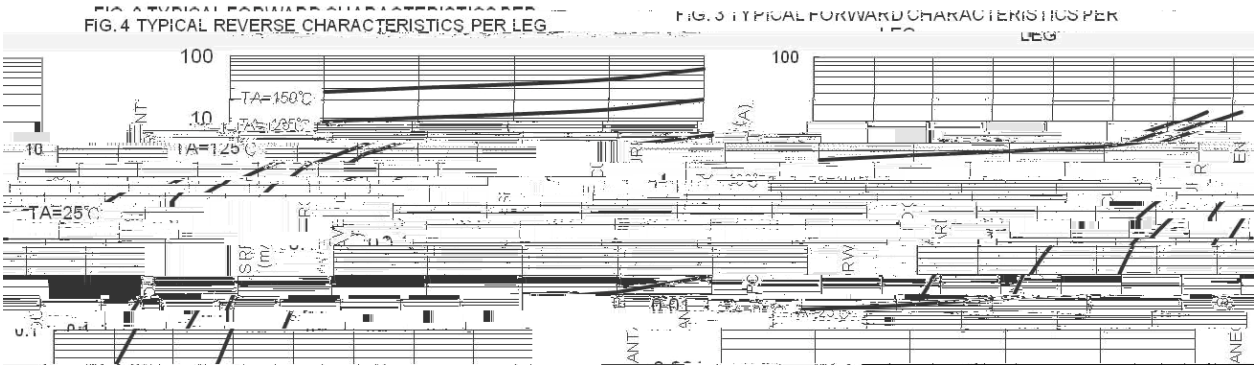


/ Pinning

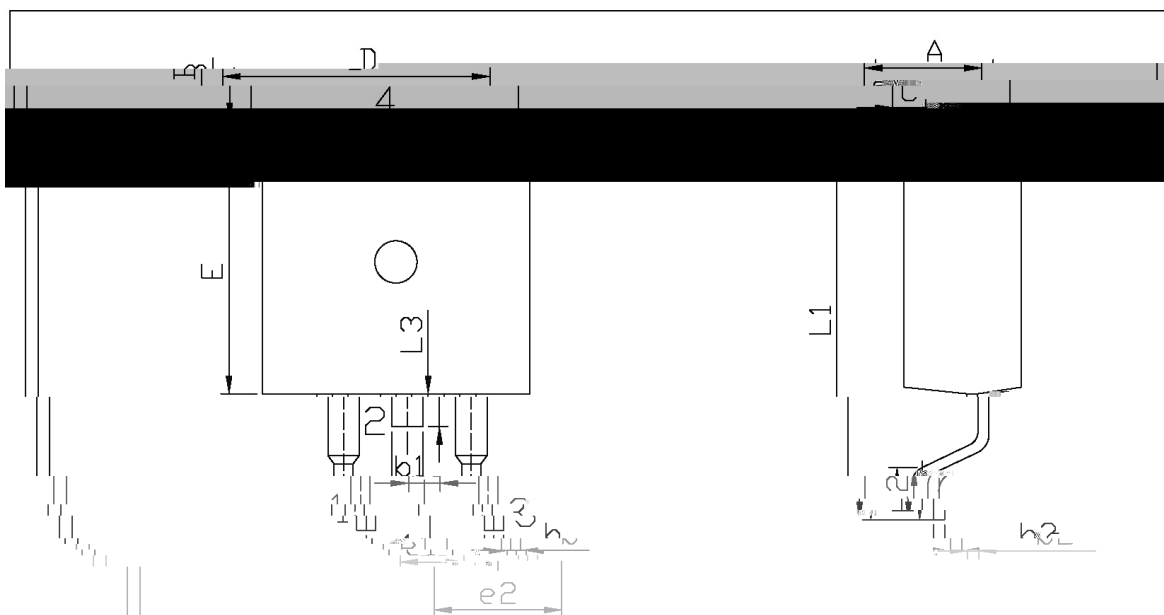


/ h_{FE} Classifications & Marking

/ Electrical Characteristic Curve



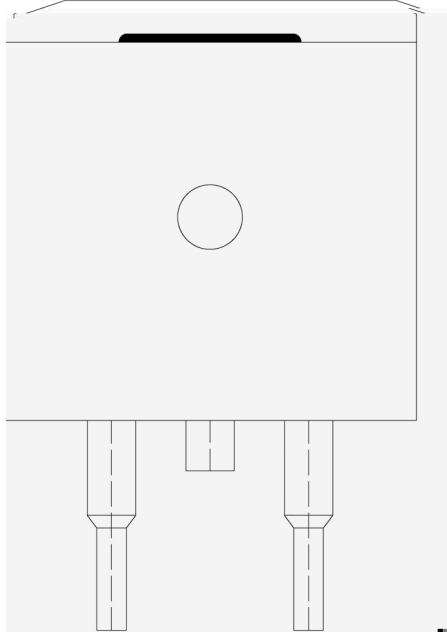
/ Package Dimensions



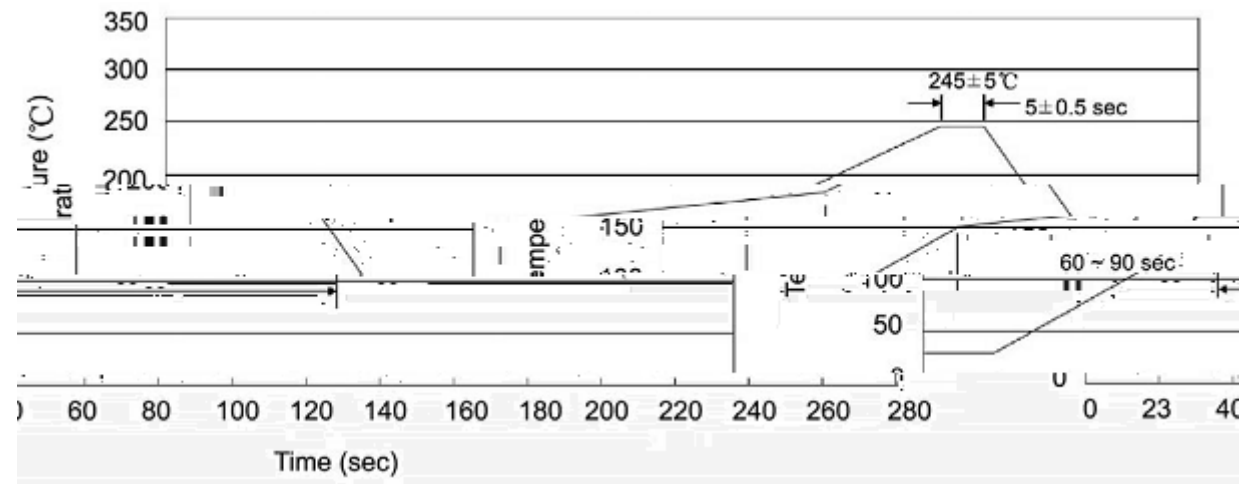
单位: mm

Dimensions In Millimeters		Dimensions In Millimeters		Dimensions In Millimeters	
Max	Min	Max	Min	Max	Min
9.40	4.30	4.70	9.00		
2.74	1.00	1.40	2.34		
42.88	62.26	0.00	0.00	0.00	0.00
15.00	16.00	b1	1.15	1.35	L1

/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

Units/Reel	Reels/Inner Box	Units/Inner Box	
/	/		